

MNLMC6484AM-X REV 0B1

 Original Creation Date: 08/16/95
 Last Update Date: 05/19/98
 Last Major Revision Date: 04/23/96

**CMOS QUAD RAIL-TO-RAIL INPUT AND OUTPUT OPERATIONAL
 AMPLIFIER**
General Description

The LMC6484 provides a common-mode range that extends to both supply rails. This rail-to-rail performance combined with excellent accuracy, due to a high CMRR, makes this device unique among rail-to-rail input amplifiers.

It is ideal for systems, such as data acquisition, that require a large input signal range. The LMC6484 is also an excellent upgrade for circuits using limited common-mode range amplifiers such as the TLC274 and TLC279.

Maximum dynamic signal range is assured in low voltage and single supply systems by the LMC6484's rail-to-rail output swing. The LMC6484's rail-to-rail output swing is guaranteed for loads down to 600 Ohms.

Guaranteed low voltage characteristics and low power dissipation make the LMC6484 especially well-suited for battery-operated systems.

See the MNLMC6482AM-X data sheet for a Dual CMOS operational amplifier with these same features.

Industry Part Number

LMC6484AM

NS Part Numbers

 LMC6484AMJ/883*
 LMC6484AMWG/883**

Prime Die

LMC6484

Controlling Document

5962-9453402MCA*,QXA**

Processing

MIL-STD-883, Method 5004

Quality Conformance Inspection

MIL-STD-883, Method 5005

Subgrp	Description	Temp (°C)
1	Static tests at	+25
2	Static tests at	+125
3	Static tests at	-55
4	Dynamic tests at	+25
5	Dynamic tests at	+125
6	Dynamic tests at	-55
7	Functional tests at	+25
8A	Functional tests at	+125
8B	Functional tests at	-55
9	Switching tests at	+25
10	Switching tests at	+125
11	Switching tests at	-55

Features

(Typical Unless Otherwise Noted)

- Rail-to-Rail input common-mode voltage range.
(Guaranteed Over Temperature)
- Rail-to-Rail output swing.
(within 20mV of supply rail, 100k Ohm load)
- Guaranteed 5V and 15V performance.
- Operates at 3V
- Excellent CMRR and PSRR. 82dB
- Ultra low input current. 20fA
- High voltage gain (Rl = 500k Ohms). 130dB
- Specified for 2k Ohm and 600 Ohm loads.

Applications

- Data Acquisition Systems.
- Transducer Amplifiers.
- Hand-held Analytic Instruments.
- Medical Instrumentation.
- Active Filter, Peak Detector, Sample and Hold, pH Meter, Current Source.
- Improved Replacement for TLC274, TLC279.

(Absolute Maximum Ratings)

(Note 1)

Supply Voltage (V+ - V-)	16V
Differential Input Voltage	±Supply Voltage
Voltage at Input/Output Pin	(V+)+0.3V, (V-)-0.3V
Current at Input Pin (Note 6)	±5mA
Current at Output Pin (Note 3, 5)	±30mA
Current at Power Supply Pin	40mA
Maximum Junction Temperature (Note 4)	150 C
Power Dissipation (Note 2)	315mW
Storage Temperature Range	-65 C to +150 C
Operating Temperature Range	-55 C ≤ TA ≤ +125 C
Thermal Resistance	
ThetaJA	
14-Pin CERAMIC DIP (Still Air)	86.0 C/W
(500LF/Min Air flow)	49.0 C/W
14-Pin CERAMIC SOIC (Still Air)	116.0 C/W
(500LF/Min Air Flow)	72.0 C/W
ThetaJC	
14-Pin CERAMIC DIP	16.0 C/W
14-Pin CERAMIC SOIC	11.0 C/W
Package Weight	
CERAMIC DIP	TBD
CERAMIC SOIC	460mg
Lead Temperature (Soldering, 10 seconds)	260 C
ESD Tolerance (Note 7)	3.0kV

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.

Note 2: The maximum power dissipation must be derated at elevated temperatures and is dictated by Tjmax (maximum junction temperature), ThetaJA (package junction to ambient thermal resistance), and TA (ambient temperature). The maximum allowable power dissipation at any temperature is Pdmax = (Tjmax - TA)/ThetaJA or the number given in the Absolute Maximum Ratings, whichever is lower.

Note 3: Applies to both single-supply and split-supply operation. Continuous short circuit operation at elevated ambient temperature can result in exceeding the maximum allowed junction temperature of 150 C. Output currents in excess of ±30mA over long term may adversely affect reliability.

Note 4: All numbers apply for packages soldered directly into a PC board.

Note 5: Do not short circuit output to V+, when V+ is greater than 13V or reliability will be adversely affected.

(Continued)

- Note 6: Limiting input pin current is only necessary for input voltages that exceed absolute maximum input voltage ratings.
- Note 7: Human body model, 1.5k Ohms in series with 100pF. All pins rated per method 3015.6 of MIL-STD-883. This is a Class 2 device rating.

Recommended Operating Conditions

(Note 1)

Supply Voltage

$$3.0V \leq V+ \leq 15.5V$$

- Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.

Electrical Characteristics

DC PARAMETERS

(The following conditions apply to all the following parameters, unless otherwise specified.)
 DC: $V_+=5V$, $V_-=0V$, $R_l > 1M$, $V_{cm} = V_o = V_+/2$

SYMBOL	PARAMETER	CONDITIONS	NOTES	PIN-NAME	MIN	MAX	UNIT	SUB-GROUPS
Vio	Input Offset Voltage				0.75		mV	1
					1.35		mV	2, 3
Iib	Input Bias Current				25		pA	1
					100		pA	2, 3
Iio	Input Offset Current				25		pA	1
					100		pA	2, 3
CMRR	Common Mode Rejection Ratio	$0V \leq V_{cm} \leq 15.0V$, $V_+ = 15V$			65		dB	1
					62		dB	2, 3
		$0V \leq V_{cm} \leq 5.0V$			65		dB	1
					62		dB	2, 3
+PSRR	Positive Power Supply Rejection Ratio	$5V \leq V_+ \leq 15V$, $V_o = 2.5V$			65		dB	1
					62		dB	2, 3
-PSRR	Negative Power Supply Rejection Ratio	$-5V \leq V_- \leq -15V$, $V_o = -2.5V$, $V_+ = 0V$			65		dB	1
					62		dB	2, 3
Vcm	Input Common Mode Voltage Range	$5V \leq V_{CM} \leq 15V$, For CMRR $\geq 50dB$			$V_{++} + 0.25$	-0.25	V	1
					V_+	0	V	2, 3
Isc	Output Short Circuit Current	Sourcing, $V_o = 0V$			16		mA	1
					12		mA	2, 3
		Sinking, $V_o = 5V$			11		mA	1
					9		mA	2, 3
		$V_+ = 15V$, Sourcing, $V_o = 0V$			28		mA	1
					22		mA	2, 3
$V_+ = 15V$, Sinking, $V_o = 12V$			1		30		mA	1
			1		24		mA	2, 3
Icc	Supply Current	All four Amps				2.8	mA	1
						3.6	mA	2, 3
		All four amps, $V_+ = +15V$				3.0	mA	1
						4.0	mA	2, 3

Electrical Characteristics

DC PARAMETERS (Continued)

(The following conditions apply to all the following parameters, unless otherwise specified.)
DC: $V_+=5V$, $V_-=0V$, $R_l > 1M$, $V_{cm} = V_o = V_+/2$

SYMBOL	PARAMETER	CONDITIONS	NOTES	PIN-NAME	MIN	MAX	UNIT	SUB-GROUPS
Vo	Output Swing	$V_+=5V$, $R_l=2K$ Ohms to $V_+/2$			4.8	0.18	V	4
					4.7	0.24	V	5, 6
		$V_+=5V$, $R_l=600$ Ohms to $V_+/2$			4.5	0.50	V	4
					4.24	0.65	V	5, 6
		$V_+=15V$, $R_l=2K$ Ohms to $V_+/2$			14.4	0.32	V	4
					14.2	0.45	V	5, 6
$V_+=15V$, $R_l=600$ Ohms to $V_+/2$			13.4	1.00	V	4		
			13.0	1.30	V	5, 6		
Av	Large Signal Voltage Gain	$R_l=2K$ Ohms Sourcing	2		140		V/mV	4
			2		84		V/mV	5, 6
		$R_l=2K$ Ohms Sinking	2		35		V/mV	4
			2		20		V/mV	5, 6
		$R_l=600$ Ohms Sourcing	2		80		V/mV	4
			2		48		V/mV	5, 6
		$R_l=600$ Ohms Sinking	2		18		V/mV	4
			2		13		V/mV	5, 6

AC PARAMETERS

(The following conditions apply to all the following parameters, unless otherwise specified.)
AC: $V_+=5V$, $V_-=0V$, $R_l > 1M$, $V_{cm} = V_o = V_+/2$

Sr	Slew Rate		3		0.9		V/uS	4
			3		0.6		V/uS	5, 6
Gbw	Gain Bandwidth	$V_+=15V$, set up for non-inverting			1.25		MHz	4
					1.15		MHz	5, 6

Note 1: Do not short circuit output to V_+ , when V_+ is greater than 13V or reliability will be adversely affected.

Note 2: $V_+=15V$, $V_{cm}=7.5V$ and R_l connected to 7.5V. For Sourcing tests, $7.5V \leq V_o \leq 11.5V$. For Sinking tests, $3.5V \leq V_o \leq 7.5V$.

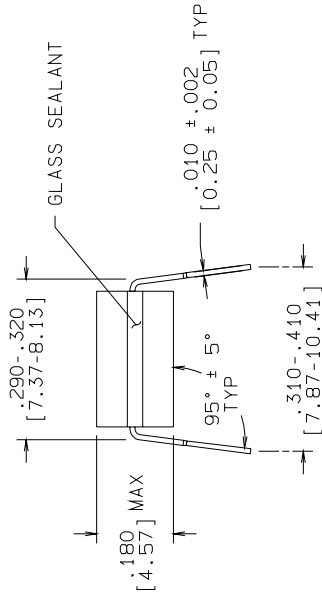
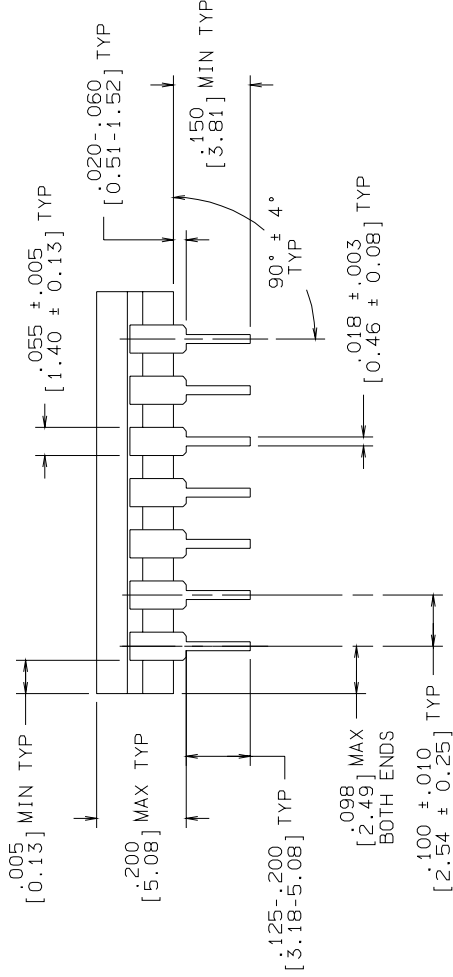
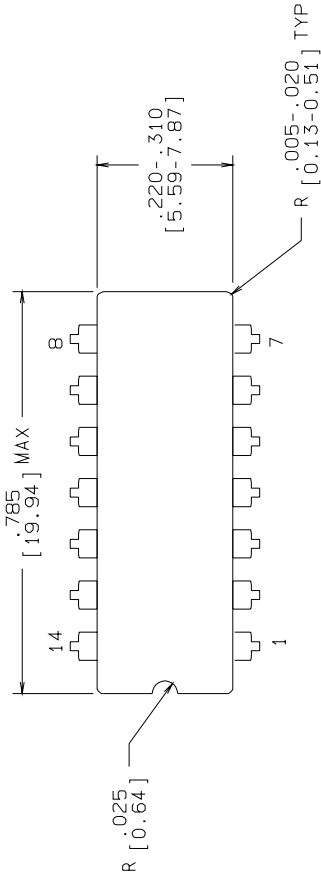
Note 3: $V_+=15V$. Connected as Voltage Follower with 10V step input, 2.5V to 12.5V for +Slew, and 12.5V to 2.5V for -Slew. Number specified is the slower of either the positive or negative slew rates.

Graphics and Diagrams

GRAPHICS#	DESCRIPTION
06087HRB4	CERDIP (J), 14 LEAD (B/I CKT)
06213HRA3	CERAMIC SOIC (WG), 14LD (B/I CKT)
J14ARH	CERDIP (J), 14 LEAD (P/P DWG)
P000117A	CERDIP (J), 14 LEAD (PIN OUT)
P000359A	CERAMIC SOIC (WG), 14 LEAD (PINOUT)
WG14ARC	CERAMIC SOIC (WG), 14LD (P/P DWG)

See attached graphics following this page.

R E V I S I O N S			
LTR	DESCRIPTION	E.C.N.	DATE
H	REVISE PER CURRENT STD; REDRAW	10001	09/15/93
			TL/



CONTROLLING DIMENSION: INCH

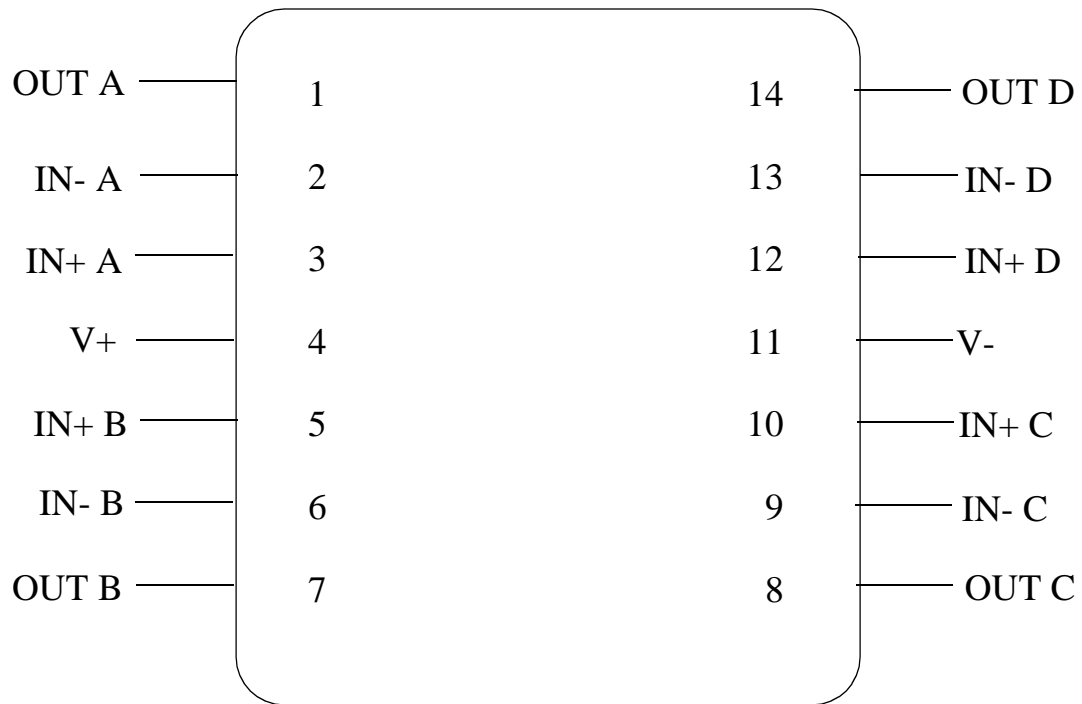
NOTES: UNLESS OTHERWISE SPECIFIED

1. LEAD FINISH TO BE 200 MICRONS / 5.08 MICROMETERS MINIMUM SOLDER MEASURED AT THE CREST OF THE MAJOR FLATS.
2. JEDEC REGISTRATION MO-036, VARIATION AB, DATED 04/1981.

MIL/AERO MIL-M-38510
 CONFIGURATION CONTROL CONFIGURATION CONTROL

APPROVALS	DATE	APPROVALS	DATE
DRAWN: T. LEQUANG	09/15/93	NATIONAL SEMICONDUCTOR CORPORATION	
DFTG. CHK.		2900 Semiconductor Drive, Santa Clara, CA 95052-8090	
ENGR. CHK.			
APPROVAL			
 PROJECTION INCH [MM]		SCALE	SIZE
		N/A	B
		DRAWING NUMBER	REV
		MKT-J14A	H
		DO NOT SCALE DRAWING	SHEET 1 OF 1

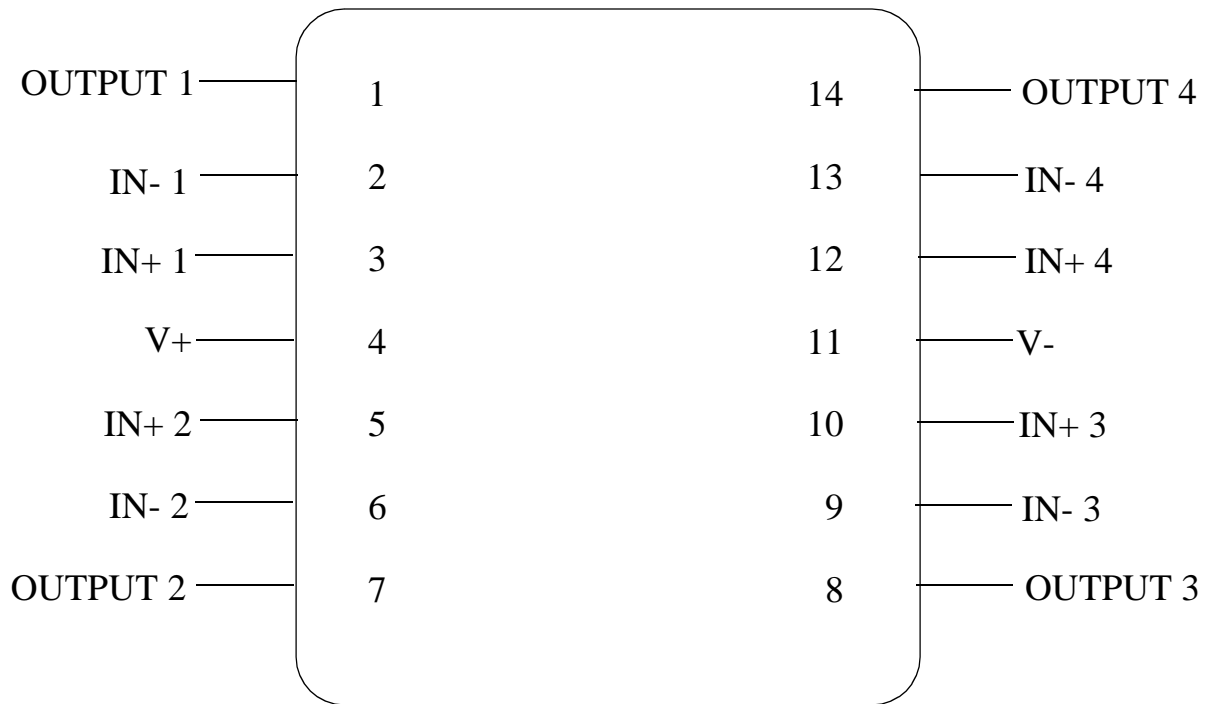
CERDIP (J),
 14 LEAD,



LMC6484AMJ
14 - LEAD DIP
CONNECTION DIAGRAM
TOP VIEW
P000117A



National Semiconductor™
MIL/AEROSPACE OPERATIONS
2900 SEMICONDUCTOR DRIVE
SANTA CLARA, CA 95050



LMC6484AMWG
14 - LEAD CERAMIC SOIC
CONNECTION DIAGRAM

TOP VIEW
P000359A

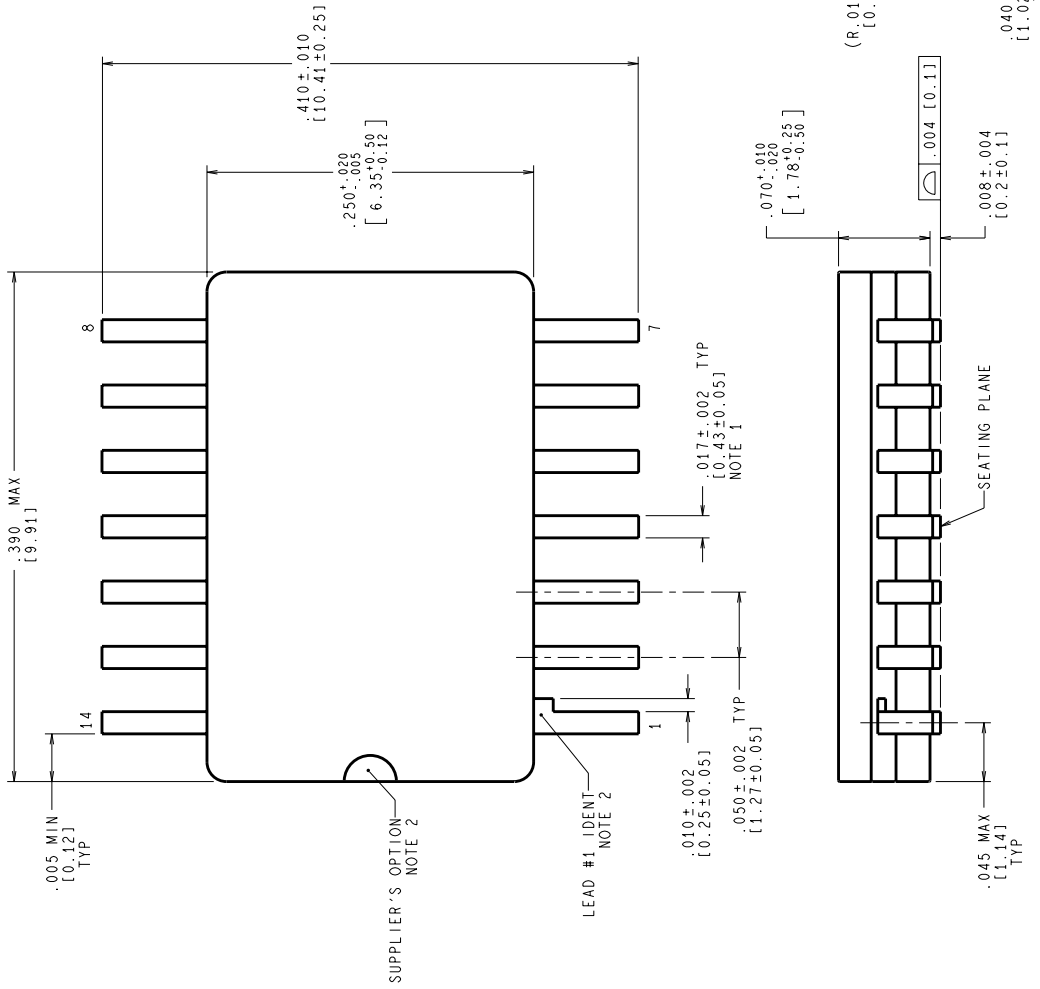


National Semiconductor™

MIL/AEROSPACE OPERATIONS
 2900 SEMICONDUCTOR DRIVE
 SANTA CLARA, CA 95050

REVISIONS			
LTR	DESCRIPTION	E.C.N.	DATE
A	RELEASE TO DOCUMENT CONTROL	11375	02/29/1996
B	LD PITCH TOL WAS ±.005; CHANGE LD RADIUS TO REF DIM; REMOVE THE OTHER R.006±.002; DIM. .040±.003 WAS .037±.003	11442	04/19/1996
C	R.015(0.38) WAS R.006(0.15)	11839	10/08/1997

LTR	DESCRIPTION	E.C.N.	DATE	BY/APP'D
A	RELEASE TO DOCUMENT CONTROL	11375	02/29/1996	MS/KH
B	LD PITCH TOL WAS ±.005; CHANGE LD RADIUS TO REF DIM; REMOVE THE OTHER R.006±.002; DIM. .040±.003 WAS .037±.003	11442	04/19/1996	MS/KH
C	R.015(0.38) WAS R.006(0.15)	11839	10/08/1997	TL/



MIL-PRF-38535
CONFIGURATION CONTROL

CONTROLLING DIMENSION IS INCH
VALUES IN | | ARE MILLIMETERS

- NOTES: UNLESS OTHERWISE SPECIFIED
- LEAD FINISH: SOLDER DIPPED WITH Sn60 OR Sn63 SOLDER CONFORMING TO MIL-PRF-38535 TO A MINIMUM THICKNESS OF 200 MICRONS/5.08 MICROMETERS. SOLDER MAY BE APPLIED OVER LEAD BASIS METAL OR Sn PLATE. MAXIMUM LIMIT MAY BE INCREASED BY .003 IN/ 0.08mm AFTER LEAD FINISH APPLIED.
 - LEAD 1 IDENTIFICATION SHALL BE:
 - A NOTCH OR OTHER MARK WITHIN THIS AREA
 - A TAB ON LEAD 1, EITHER SIDE
 - NO JEDEC REGISTRATION AS OF FEBRUARY 1996.

APPROVALS	DATE	02/29/96
DRN	MARYA SUCHY	
DATE		
ENGR. CHK.		
PROJECTION		
SCALE	N/A	C
DRAWING NUMBER	(SC)MKT-WG14A	C
REV		

National Semiconductor
 2800 Semiconductor Dr., Santa Clara, CA 95052-8000
**CERPACK,
 14 LEAD,
 GULL WING**

DO NOT SCALE DRAWING SHEET 1 of 1

Revision History

Rev	ECN #	Rel Date	Originator	Changes
0B1	M0002884	05/19/98	Rose Malone	Update MDS: MNLMC6484AM-X Rev. 0A0 to MNLMC6484AM-X Rev. 0B1. Updated subgroups to match SMD. Updated Pinout and MKT graphics for WG package. Updated B/I CKT's. Added Package Weight.